

**Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1. (Currently amended) A method for producing a photonic crystal in which a first dielectric and a second dielectric different in relative dielectric constant from said first dielectric are periodically arrayed, characterized by comprising the steps of:

fabricating a first composite dielectric in which said first dielectric and said second dielectric are periodically arrayed in one and the same plane; and

laminating on said first composite dielectric a second composite dielectric in which said first dielectric and said second dielectric are periodically arrayed in one and the same plane; and,

said first composite dielectric and said second composite dielectric are obtained by use of a printing technique, wherein said first composite dielectric has holes obtained by use of said printing technique which penetrate along the thickness direction thereof and are formed in a predetermined pattern, and said first dielectric and said second dielectric each are a dielectric ceramic.

2. (Cancelled)

3. (Currently amended) The method for producing a photonic crystal according to claim 21, characterized in that a dielectric block having a predetermined pattern of openings periodically arrayed is obtained by laminating said first composite dielectric and said second composite dielectric, wherein each of said second composite dielectrics has holes obtained by use of said printing technique which penetrate along the thickness direction thereof and are formed in a predetermined pattern.

4. (Currently amended) The method for producing a photonic crystal according to claim 3, characterized in that said predetermined pattern of openings penetrate through said dielectric block from the front surface to the back surface thereof, and air-as said second dielectric is placed in the openings.

5-6. (Cancelled)

7. (Previously presented) The method for producing a photonic crystal according to claim 1, characterized in that lamination of said first composite dielectric and said second composite dielectric is carried out by use of said printing technique.

8. (Cancelled)

9. (Currently amended) The method for producing a photonic crystal according to claim 8 1, characterized by further comprising the steps of:  
    laminating said first composite dielectric and said second composite dielectric to obtain a dielectric block having a predetermined pattern of openings periodically arrayed wherein ~~each of said first~~ first composite dielectrics is sheet-like and said second composite dielectric is sheet-like and has holes obtained by use of said printing technique which penetrate along the thickness direction thereof and are formed in a predetermined pattern; and  
    arraying said second dielectric in said openings.

10. (Original) The method for producing a photonic crystal according to claim 9, characterized in that a powder slurry comprising said second dielectric is filled in the openings of said dielectric block.

11. (Original) The method for producing a photonic crystal according to claim 10, characterized in that filling of said powder slurry is carried out by suction or pressurization.

12. (Original) The method for producing a photonic crystal according to claim 9, characterized in that said predetermined pattern of openings penetrate through said dielectric block from the front surface to the back surface thereof.

13. (Original) The method for producing a photonic crystal according to claim 10, characterized in that a powder slurry comprising said second dielectric is filled in said openings of said dielectric block, and thereafter said first dielectric and said second dielectric are co-fired.

14. (Original) The method for producing a photonic crystal according to claim 9, characterized in that said first composite dielectric and said second composite dielectric each have a thickness from 1 to 800  $\mu\text{m}$ .

15. (Currently amended) The method for producing a photonic crystal according to claim 8 1, characterized in that said first composite dielectric and said second composite dielectric each are a ceramic composite, and said ceramic composite is fabricated by:

arraying a first ceramic composition constituting said first dielectric on the sites corresponding to said first dielectric; and

arraying a second ceramic composition constituting said second dielectric on the sites corresponding to said second dielectric.

16. (Original) The method for producing a photonic crystal according to claim 15, characterized in that a plurality of said ceramic composites are laminated, wherein said plurality of said ceramic composites are obtained by arraying said first ceramic composition and thereafter arraying said second ceramic composition.

17. (Original) The method for producing a photonic crystal according to claim 15, characterized in that:

said ceramic composite is fabricated by arraying said first ceramic composition and thereafter arraying said second ceramic composition; and

said ceramic composite is laminated by repeating the step of arraying any one of said first ceramic composition and said second ceramic composition on said ceramic composite, and thereafter arraying the other of said first ceramic composition and said second ceramic composition thereon.

18. (Original) The method for producing a photonic crystal according to claim 16 or 17, characterized by further comprising a step of firing the laminated body formed of said ceramic composite.

19. (Original) The method for producing a photonic crystal according to claim 1, characterized in that said photonic crystal has a two-dimensional periodic structure.

20-22. (Cancelled)

23. (Currently amended) A method for producing a photonic crystal in which a first dielectric and a second dielectric different in relative dielectric constant from said first dielectric are periodically arrayed, characterized by comprising the steps of:

fabricating a first composite dielectric in which said first dielectric and said second dielectric are periodically arrayed in one and the same plane; and

laminating on said first composite dielectric a second composite dielectric by thermocompression bonding in which said first dielectric and said second dielectric are periodically arrayed in one and the same plane; and said first composite dielectric and said second composite dielectric are each obtained by perforating holes in a sheet-like member, and said first dielectric and said second dielectric each are a dielectric ceramic.

24. (Cancelled)

25. (Currently amended) The method for producing a photonic crystal according to claim 2423, characterized in that a dielectric block having a predetermined pattern of openings periodically arrayed is obtained by laminating said first composite dielectric and said second composite dielectric, wherein each of said composite dielectrics has holes which penetrate along the thickness direction thereof and are formed in a predetermined pattern.

26. (Currently amended) The method for producing a photonic crystal according to claim 25, characterized in that said predetermined pattern of openings penetrate through said dielectric block from the front surface to the back surface thereof, and air as said second dielectric is placed in the openings.

27. (Cancelled)

28. (Currently amended ) The method for producing a photonic crystal according to claim 27 23, characterized by further comprising the steps of:

laminating said first composite dielectric and said second composite dielectric to obtain a dielectric block having a predetermined pattern of openings periodically arrayed wherein each of said composite dielectrics is sheet-like and has

holes which penetrate along the thickness direction thereof and are formed in a predetermined pattern; and  
arraying said second dielectric in said openings.

29. (Previously presented) The method for producing a photonic crystal according to claim 28, characterized in that a powder slurry comprising said second dielectric is filled in the openings of said dielectric block.

30. (Previously presented) The method for producing a photonic crystal according to claim 29, characterized in that filling of said powder slurry is carried out by suction or pressurization.

31. (Previously presented) The method for producing a photonic crystal according to claim 28, characterized in that said predetermined pattern of openings penetrate through said dielectric block from the front surface to the back surface thereof.

32. (Previously presented) The method for producing a photonic crystal according to claim 29, characterized in that a powder slurry comprising said second dielectric is filled in said openings of said dielectric block, and thereafter said first dielectric and said second dielectric are co-fired.

33. (Previously presented) The method for producing a photonic crystal according to claim 28, characterized in that said first composite dielectric and said second composite dielectric each have a thickness from 1 to 800  $\mu\text{m}$ .

34. (Previously presented) The method for producing a photonic crystal according to claim 27 23, characterized in that said first composite dielectric and said second composite dielectric each are a ceramic composite, and said ceramic composite is fabricated by:

arraying a first ceramic composition constituting said first dielectric on the sites corresponding to said first dielectric; and

arraying a second ceramic composition constituting said second dielectric on the sites corresponding to said second dielectric.

35. (Previously presented) The method for producing a photonic crystal according to claim 34, characterized in that a plurality of said ceramic composites are laminated, wherein said plurality of said ceramic composites are obtained by arraying said first ceramic composition and thereafter arraying said second ceramic composition.

36. (Previously presented) The method for producing a photonic crystal according to claim 34, characterized in that:

said ceramic composite is fabricated by arraying said first ceramic composition and thereafter arraying said second ceramic composition; and

said ceramic composite is laminated by repeating the step of arraying any one of said first ceramic composition and said second ceramic composition on said ceramic composite, and thereafter arraying the other of said first ceramic composition and said second ceramic composition thereon.

37. (Previously presented) The method for producing a photonic crystal according to claim 35 or 36, characterized by further comprising a step of firing the laminated body formed of said ceramic composite.

38. (Previously presented) The method for producing a photonic crystal according to claim 23, characterized in that said photonic crystal has a two-dimensional periodic structure.

39. (New) The method for producing a photonic crystal according to claim 1, characterized in that said second composite dielectric has holes obtained by use of said printing technique which penetrate along the thickness direction thereof and are formed in a predetermined pattern.